



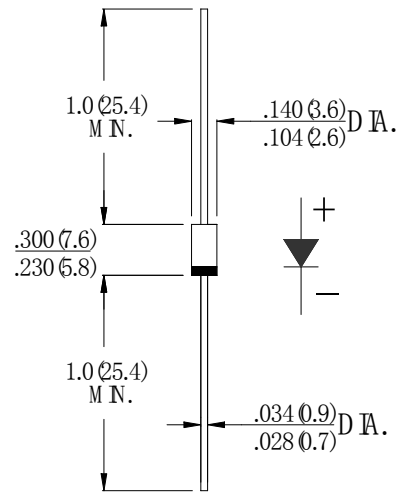
PINGWEI ENTERPRISE

UF201 THRU UF207**2.0AMPS. SILICON ULTRA FAST RECTIFIERS****FEATURE**

- . Low leakage
- . Low forward voltage drop
- . High current capability
- . High surge capability
- . High reliability
- . High temperature soldering guaranteed
260°C /10sec / 0.375" lead length at 5 lbs tension

MECHANICAL DATA

- . Terminal: Plated axial leads solderable per
MIL-STD 202E, method 208C
- . Case: Molded with UL-94 Class V-0 recognized
Flame Retardant Epoxy
- . Polarity: color band denotes cathode
- . Mounting position: any

DO-15

Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	SYMBOL	UF 201	UF 202	UF 203	UF 204	UF 205	UF 206	UF 207	units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current .375"(9.5mm) lead length at T _A =55°C	$I_{F(AV)}$	2.0							A
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	60							A
Maximum Instantaneous forward Voltage at 2.0A DC	V_F	1.0				1.7			V
Maximum DC Reverse Current @T _A =25°C at rated DC blocking voltage @T _A =100°C	I_R	5.0 100.0							μA
Maximum Reverse Recovery Time (Note 1)	t_{rr}	50				75			ns
Typical Junction Capacitance (Note 2)	C_J	50				30			pF
Typical Thermal Resistance (Note 3)	$R_{(JA)}$	75							°C/W
Storage Temperature	T_{STG}	-55 to +150							°C
Operation Junction Temperature	T_J	-55 to +150							°C

Note:

1. Test Conditions: $I_F = 0.5\text{A}$, $I_R = 1.0\text{A}$, $I_{RR} = 0.25\text{A}$
2. Measured at 1.0 MHz and applied reverse voltage of 4.0Vdc
3. Thermal Resistance from Junction to Ambient at 0.375" (9.5mm) lead length, vertical P.C. Board Mounted.